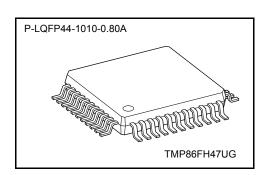
# CMOS 8-Bit Microcontroller TMP86FH47UG

The TMP86FH47 is a high-speed, high-performance 8-bit microcomputer built around the TLCS-870/C Series core with built-in 16-Kbyte flash memory and it is pin compatible with its mask ROM version, the TMP86C845/847/H47. Writing programs in the built-in flash memory enables this microcomputer to perform the same operations as the TMP86C847/H47. About TMP86C845, please refer to "Difference between TMP86C845 and TMP86Cx47". The built-in flash memory can be rewritten on board (without removing it from the PCB) by a built-in boot program.

| Product No. | Flash Memory   | RAM          | Package             |
|-------------|----------------|--------------|---------------------|
| TMP86FH47UG | 16384 × 8 bits | 512 × 8 bits | P-LQFP44-1010-0.80A |

### **Feautures**

- ♦ 8-bit single chip microcomputer TLCS-870/C series
- Instruction execution time: 0.25 μs (at 16 MHz)
   122 μs (at 32.768 kHz)
- ♦ 132 types and 731 basic instructions
- ♦ 18 interrupt sources (External: 6, Internal: 12)
- ♦ Input/output ports (35 pins)
- ♦ 8-bit timer counter: 2 ch
  - · Timer, PWM, PPG, PDO, Event counter modes
- ♦ Time base timer
- ♦ Watchdog timer
  - Interrupt sources/reset output (Programmable)
- ♦ Serial interface
  - 8-bit SIO: 1 ch
  - 8-bit UART: 1 ch



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- ♦ 10-bit successive approximation type AD converter
  - · Analog input: 8 ch
- ♦ 16-bit timer counter: 1 ch
  - Timer, event counter, pulse width measurment, programmable pulse generator (PPG), external-triggered timer, window modes
- ♦ Key-on wakeup: 4 ch
- ♦ Dual clock operation
  - Single/dual-clock mode
- Nine power saving operating modes
  - STOP mode: Oscillation stops. Battery/capacitor backup.
    - Port output hold/high-impedance.
  - SLOW 1, 2 mode: Low power consumption operation using low-frequency clock (32.768 kHz)
  - IDLE 0 mode: CPU stops, and peripherals operate using high-frequency clock of time-base-timer. Release by INTTBT interrupt.
  - IDLE 1 mode: CPU stops, and peripherals operate using high-frequency clock.
    - Release by interrupts.
  - IDLE 2 mode: CPU stops, and peripherals operate using high and low frequency clock.
    - Release by interrupts.
  - SLEEP 0 mode: CPU stops, and peripherals operate using low-frequency clock of time
    - base-timer. Release by INTTBT interrupt.
  - SLEEP 1 mode: CPU stops, and peripherals operate using low-frequency clock.
    - Release by interrupts.
  - SLEEP 2 mode: CPU stops, and peripherals operate using high and low frequency clock.
    - Release by interrupts.
- ♦ Wide operating voltage: 4.5 to 5.5 V at 16 MHz/32.768 kHz
  - 2.7 to 5.5 V at 8 MHz/32.768 kHz

Note: The operating voltage, the operating temperature and the operating current are different between TMP86FH47 and TMP86C845/847/H47.

About details, please refer to electrical characteristics of each products.

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# Difference Between TMP86C845 and TMP86Cx47

|              |                  |                 | TMP86Cx47U  |                   | TMP86C845U   |  |
|--------------|------------------|-----------------|---|-------------------|--|--|
|              | ·                | TMP86C847U      | TMP86CH47U  | TMP86CM47U        | 110170000430   |  |
| ROM (Byte    | e)               | 8 K             | 16 K  | 32 K              | 8 K  |  |
| RAM (Byte    | ;)               | 512             | 512   | 1 K               | 256  |  |
| I/O          |                  |                 | 35  |                   | 35   |  |
| Package (E   | Body size)       |                 | QFP44 (10 × 10 mm)  |                   | QFP44 (10 × 10 mm)                                       |  |
| Min instruc  | tion             |                 | 0.25 μs (at 16 MHz)   |                   | 0.5 μs (at 8 MHz)  |  |
| Supply volt  | tage             | 2.7 to          | 5.5 V at 4.2 MHz/32.76<br>5.5 V at 8.0 MHz/32.76<br>5.5 V at 16 MHz/32.76 | 88 kHz            | 2.7 to 5.5 V at 8.0 MHz/<br>32.768 kHz                   |  |
| 16-bit time  | r/counter        |                 | 1 ch  |                   | -  |  |
| 8-bit timer/ | counter          | 2 ch            |   |                   | 2 ch   |  |
| Time base    | timer            | 1 ch            |   | 1 ch              |  |  |
| Watchdog     | timer            | 1 ch            |   | 1 ch              |  |  |
| AD conver    | ter              |                 | 8 ch  |                   | 8 ch   |  |
| Serial I/O   |                  | Clocked         | Clocked synchronous: 1 ch, UART: 1 ch                                     |                   | Clocked synchronous: 1 ch                                |  |
| Key on wa    | keup             |                 | 4 ch  |                   | -  |  |
| Warm-up o    | counter          |                 | 6   |                   | 4  |  |
| I/O          | Hysteresis input |                 | P0, P1, P2 port   |                   | Port2, P00, P05, P06, P07,<br>P10, P11, P12, P15 pin     |  |
| Circuitry    | CMOS<br>input    |                 | P3, P4 port   |                   | Port3, Port4, P01, P02, P03, P04, P13, P14, P16, P17 pin |  |
|              | RESET            | Watchdog timer, | Adress trap, System c   | lock reset output | Input only   |  |
| Operation 7  | Temp.            |                 | –40 to 85°C   |                   | −40 to 85°C  |  |

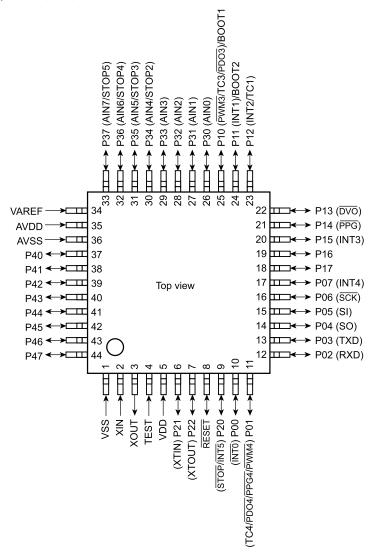
are difference points between TMP86C845 and TMP86Cx47.

Please refer to "Input/Output Circutry" of TMP86C847/H47/M47 and TMP86C845 for details.

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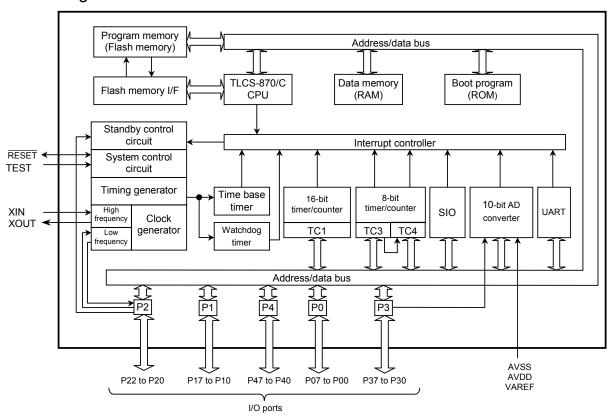
# Pin Assignments (Top view)

P-LQFP44-1010-0.80A



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# **Block Diagram**



## Pin Function

The TMP86FH47 has MCU mode and serial PROM mode.

#### (1) MCU mode

In the MCU mode, the TMP86FH47 is a pin compatible with the TMP86C845/847/H47 (Make sure to fix the TEST pin to low level).

#### (2) Serial PROM mode

The serial PROM mode is set by fixing TEST pin, P10 and P11 at "high" respectively when  $\overline{\text{RESET}}$  pin is fixed "low".

After release of reset, the built-in BOOT ROM program is activated and the built-in flash memory is rewritten by serial I/F (UART).

| Pin Name<br>(Serial PROM mode)                             | Input/<br>Output | Functions Pin Name (MCU mode)   |      |  |  |  |
|--|------------------|---|------|--|--|--|
| BOOT1/RXD  | Input/Input      | Fix "High" during reset. This pin is used as RXD pin after releasing reset. | P10  |  |  |  |
| BOOT2/TXD  | Input/Output     | Fix "High" during reset. This pin is used as TXD pin after releasing reset. | P11  |  |  |  |
| TEST   | Input            | Fix to "High".  |      |  |  |  |
| RESET  | I/O              | Reset signal input or an internal error reset out                           | put. |  |  |  |
| VDD, AVDD  | Power supply     | 5 V   |      |  |  |  |
| VSS, AVSS, VAREF   | Power supply     | 0 V   |      |  |  |  |
| P07 to P00, P17 to P12, P22 to P20, P37 to P30, P47 to P40 |                  | Fix to "Low" or "High".   |      |  |  |  |
| XIN  | Input            | Solf oscillation with reconstor (2 MHz, 4 MHz, 9 MHz, 16 MHz)               |      |  |  |  |
| XOUT   | Output           | Self oscillation with resonator (2 MHz, 4 MHz, 8 MHz, 16 MHz)               |      |  |  |  |

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## Operation

This section describes the functions and basic operational blocks of TMP86FH47.

The TMP86FH47 has flash memory in place of the mask ROM which is included in the TMP86C845/847/H47. The configuration and function are the same as the TMP86C847/H47. For TMP86C845, however, some functions have been partially changed or deleted. For the functions of TMP86FH47 in details, see the section of TMP86C845/847/H47.

## 1. Operating Mode

The TMP86FH47 has MCU mode and serial PROM mode.

#### 1.1 MCU Mode

The MCU mode is set by fixing the TEST pin to the low level.

In the MCU mode, the operation is the same as the TMP86C845/847/H47 (TEST pin cannot be used open because it has no built-in pull-down resistor).

#### 1.1.1 Program memory

The TMP86FH47 has a 16-Kbyte built-in flash memory (addresses C000H to FFFFH in the MCU mode).

When using TMP86FH47 for evaluation of TMP86C845/847/H47, the program is written by the serial PROM mode.

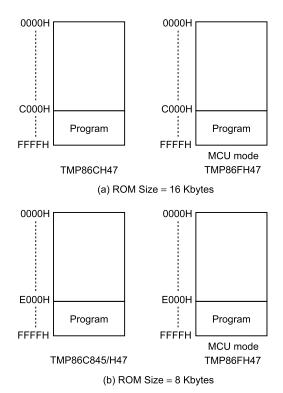


Figure 1.1.1 Program Memory Area

Note: The area that is not in use should be set data to FFH.

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## 2. Serial PROM Mode

#### 2.1 Outline

The TMP86FH47 has a 2-Kbyte BOOT ROM for programming to flash memory. This BOOT ROM is a mask ROM that contains a program to write the flash memory on-board. The BOOT ROM is available in a serial PROM mode and it is controlled by TEST pin and RESET pin and 2 I/O pins, and is communicated with UART. There are four operation modes in a serial PROM mode: flash memory writing mode, RAM loader mode, flash memory SUM output mode and product discrimination code output mode. Operating area of serial PROM mode differs from that of MCU mode. The operating area of serial PROM mode shows in Table 2.1.1.

| Parameter         | Symbol          | Min   | Max   | Unit |
|-------------------|-----------------|-------|-------|------|
| Operating voltage | V <sub>DD</sub> | 4.5   | 5.5   | V    |
| High frequency    | fc              | 2, 4, | 8, 16 | MHz  |
| Temperature       | Topr            | 25    | °C    |      |

Table 2.1.1 Operating Area of Serial PROM Mode

# 2.2 Memory Mapping

The BOOT ROM is mapped in address F800H to FFFFH. The BOOT ROM can't be accessed in MCU mode. The Figure 2.2.1 shows a memory mapping.

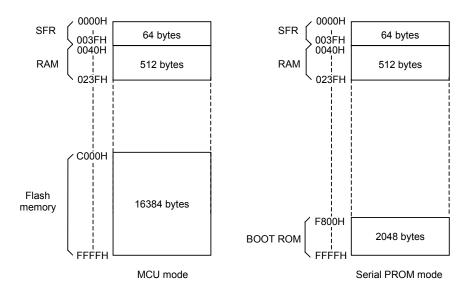


Figure 2.2.1 Memory Address Maps

# **Electrical Characteristics**

Absolute Maximum Ratings (V<sub>SS</sub> = 0 V)

| Parameter                       | Symbol                            | Pins             | Rating                        | Unit |
|---------------------------------|-----------------------------------|------------------|-------------------------------|------|
| Supply voltage                  | $V_{DD}$                          |                  | −0.3 to 5.5                   |      |
| Input voltage                   | V <sub>IN</sub>                   |                  | -0.3 to V <sub>DD</sub> + 0.3 | V    |
| Output voltage                  | V <sub>OUT</sub>                  |                  | -0.3 to V <sub>DD</sub> + 0.3 |      |
|                                 | I <sub>OUT1</sub> I <sub>OH</sub> | P1, P3, P4 ports | -1.8                          |      |
| Output current (Per 1 pin)      | I <sub>OUT2</sub> I <sub>OL</sub> | P1, P3 ports     | 3.2                           |      |
|                                 | I <sub>OUT3</sub> I <sub>OL</sub> | P0, P2, P4 ports | 30                            | mA   |
| Output ourront (Total)          | Σl <sub>OUT1</sub>                | P1, P3 ports     | 60                            |      |
| Output current (Total)          | Σl <sub>OUT2</sub>                | P0, P2, P4 ports | 80                            |      |
| Power dissipation [Topr = 70°C] | PD                                |                  | 250                           | mW   |
| Soldering temperature (time)    | Tsld                              |                  | 260 (10 s)                    |      |
| Storage temperature             | Tstg                              |                  | -55 to 125                    | °C   |
| Operating temperature           | Tonr                              |                  | -40 to 70 (MCU mode)          |      |
| Operating temperature           | Topr                              |                  | 20 to 30 (Serial PROM mode)   |      |

Note: The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.

## Recommended Operating Condition

1) MCU mode ( $V_{SS} = 0 \text{ V}$ , Topr = -40 to 70°C)

| Parameter        | Symbol           | Pins                    | С                             | ondition                | Min                  | Max                  | Unit   |
|------------------|------------------|-------------------------|-------------------------------|-------------------------|----------------------|----------------------|--------|
|                  |                  |                         | fc = 16 MHz                   | NORMAL1, 2 mode         | 4.5                  |                      |        |
|                  |                  |                         | IC = 16 IVITZ                 | IDLE0, 1, 2 mode        | 4.5                  |                      |        |
| Supply voltage   | $V_{DD}$         |                         | fc = 8 MHz                    | NORMAL1, 2 mode         |                      | 5.5                  |        |
|                  |                  |                         | IC = 6 IVITIZ                 | IDLE0, 1, 2 mode        | 2.7                  |                      |        |
|                  |                  |                         |                               | STOP mode               |                      |                      |        |
|                  | V <sub>IH1</sub> | Except hysteresis input | V>45V                         | •                       | $V_{DD} \times 0.70$ |                      | V      |
| Input high level | V <sub>IH2</sub> | Hysteresis input        | VDD ≥ 4.5 V                   | V <sub>DD</sub> ≥ 4.5 V |                      | $V_{DD}$             |        |
|                  | V <sub>IH3</sub> |                         | V <sub>DD</sub> < 4.5 V       |                         | $V_{DD} \times 0.90$ |                      |        |
|                  | V <sub>IL1</sub> | Except hysteresis input | V <sub>DD</sub> ≥ 4.5 V       |                         |                      | $V_{DD} \times 0.30$ |        |
| Input low level  | V <sub>IL2</sub> | Hysteresis input        | VDD ≥ 4.5 V                   |                         | 0                    | $V_{DD} \times 0.25$ |        |
|                  | V <sub>IL3</sub> |                         | V <sub>DD</sub> < 4.5 V       |                         |                      | $V_{DD} \times 0.10$ |        |
|                  | fc               | XIN, XOUT               | $V_{DD} = 4.5 \text{ to } 5.$ | .5 V                    | 1.0                  | 16.0                 | MHz    |
| Clock frequency  | 10               | Ally, AOUT              | $V_{DD} = 2.7 \text{ to } 5.$ | .5 V                    | 1.0                  | 8.0                  | IVII⊐∠ |
|                  | fs               | XTIN, XTOUT             |                               |                         | 30.0                 | 34.0                 | kHz    |

# 2) Serial PROM mode ( $V_{SS} = 0 \text{ V}$ , Topr = 20 to 30°C)

| Parameter        | Symbol           | Pins                    | Condition                        | Min                  | Max                  | Unit |
|------------------|------------------|-------------------------|----------------------------------|----------------------|----------------------|------|
| Supply voltage   | $V_{DD}$         |                         | fc = 2 MHz, 4 MHz, 8 MHz, 16 MHz | 4.5                  | 5.5                  |      |
| Input high lovel | V <sub>IH1</sub> | Except hysteresis input | V <sub>DD</sub> = 4.5 to 5.5 V   | $V_{DD} \times 0.70$ | $V_{\mathrm{DD}}$    |      |
| Input high level | V <sub>IH2</sub> | Hysteresis input        | VDD = 4.3 to 3.3 V               | $V_{DD} \times 0.75$ | • 00                 | V    |
| Input low level  | $V_{IL1}$        | Except hysteresis input | V <sub>DD</sub> = 4.5 to 5.5 V   | 0                    | $V_{DD} \times 0.30$ |      |
| input low level  | $V_{IL2}$        | Hysteresis input        | VDD = 4.3 to 3.3 V               |                      | $V_{DD} \times 0.25$ |      |
| Clock frequency  | fc               | XIN, XOUT               | V <sub>DD</sub> = 4.5 to 5.5 V   | 2.0, 4.0, 8.0, 1     | 6                    | MHz  |

Note: The recommended operating conditions for a device are operating conditions under which it can be guaranteed that the device will operate as specified. If the device is used under operating conditions other than the recommended operating conditions (Supply voltage, operating temperature range, specified AC/DC values etc.), malfunction may occur. Thus, when designing products which include this device, ensure that the recommended operating conditions for the device are always adhered to.

DC Characteristics  $(V_{SS} = 0 \text{ V, Topr} = -40 \text{ to } 70^{\circ}\text{C})$ 

| Parameter                          | Symbol           | Pins                                | Condi  | tion  | Min | Тур. | Max  | Unit |
|------------------------------------|------------------|-------------------------------------|--|---|-----|------|------|------|
| Hysteresis voltage                 | $V_{HS}$         | Hysteresis input                    |  |   | -   | 0.9  | -    | V    |
|                                    | I <sub>IN1</sub> | TEST                                |  |   |     |      |      |      |
| Input current                      | I <sub>IN2</sub> | Sink open drain, tri-state          | $V_{DD} = 5.5 \text{ V}, V_{IN} = 8$                               | 5.5/0 V   | -   | -    | ±2   | μΑ   |
|                                    | I <sub>IN3</sub> | RESET, STOP                         |  |   |     |      |      |      |
| Input resistance                   | R <sub>IN2</sub> | RESET pull up                       |  |   | 100 | 200  | 450  | kΩ   |
| Output leakage                     | I <sub>LO1</sub> | Sink open drain                     | $V_{DD} = 5.5 \text{ V}, V_{OUT} =$                                | = 5.5 V   | -   | -    | 2    | μА   |
| current                            | I <sub>LO2</sub> | Tri-state                           | V <sub>DD</sub> = 5.5 V, V <sub>OUT</sub> =                        | = 5.5/0 V   | -   | -    | ±2   | μΛ   |
| Output high voltage                | V <sub>OH</sub>  | Tri-state                           | $V_{DD} = 4.5 \text{ V}, I_{OH} = -$                               | -0.7 mA   | 4.1 | -    | -    |      |
| Output low voltage                 | V <sub>OL</sub>  | Except XOUT, P0, P2 and P4 ports    | $V_{DD} = 4.5 \text{ V}, I_{OL} = 1$                               | V <sub>DD</sub> = 4.5 V, I <sub>OL</sub> = 1.6 mA |     | -    | 0.4  | V    |
| Output low current                 | I <sub>OL</sub>  | High current port (P0, P2, P4 port) | V <sub>DD</sub> = 4.5 V, V <sub>OL</sub> = 1.0 V                   |   | -   | 20   | -    |      |
| Supply current in NORMAL 1, 2 mode |                  |                                     | V <sub>DD</sub> = 5.5 V  |   | -   | 8.0  | 12.5 | A    |
| Supply current in IDLE1, 2 mode    |                  |                                     | $V_{IN} = 5.3 \text{ V}/0.2 \text{ V}$ fc = 16 MHz                 |   | -   | 6.0  | 9.0  | mA   |
| Supply current in IDLE0 mode       |                  |                                     | fs = 32.768 kHz  |   | -   | 4.5  | 9.0  |      |
| Supply current in                  |                  |                                     |  | When a program operates on flash memory           | -   | 300  | 600  |      |
| SLOW1 mode                         | I <sub>DD</sub>  |                                     | $V_{DD} = 3.0 \text{ V}$<br>$V_{IN} = 2.8 \text{ V}/0.2 \text{ V}$ | When a program operates on RAM                    | -   | 8.0  | 27   |      |
| Supply current in<br>SLEEP1 mode   |                  |                                     | fs = 32.768 kHz  |   | -   | 7.0  | 25   | μА   |
| Supply current in SLEEP0 mode      |                  |                                     |  |   | -   | 6.0  | 24   |      |
| Supply current in STOP mode        |                  |                                     | $V_{DD} = 5.0 \text{ V}$<br>$V_{IN} = 5.3 \text{ V}/0.2 \text{ V}$ |   | -   | 0.5  | 10   |      |

Note 1: Typical values show those at Topr = 25°C,  $\ensuremath{V_{DD}} = 5\ensuremath{\mbox{ V}}.$ 

Note 2: Input current ( $I_{IN3}$ ); The current through pull-up resistor is not included.

Note 3:  $I_{\mbox{\scriptsize DD}}$  does not include  $I_{\mbox{\scriptsize REF}}$  current.

AD Conversion Characteristics

$$(V_{SS} = 0 \text{ V}, 4.5 \text{ V} \le V_{DD} \le 5.5 \text{ V}, \text{Topr} = -40 \text{ to } 70^{\circ}\text{C})$$

| Parameter  | Symbol            | Condition  | Min                    | Тур.     | Max               | Unit |
|--|-------------------|--|------------------------|----------|-------------------|------|
| Analog reference voltage                         | $V_{AREF}$        |  | A <sub>VDD</sub> – 1.0 | -        | $A_{VDD}$         |      |
| Power supply voltage of analog control circuit   | A <sub>VDD</sub>  |  |                        | $V_{DD}$ |                   | V    |
| Analog reference voltage range (Note 4)          | $\Delta V_{AREF}$ |  | 3.5                    | -        | -                 | V    |
| Analog input voltage                             | $V_{AIN}$         |  | V <sub>SS</sub>        | -        | V <sub>AREF</sub> |      |
| Power supply current of analog reference voltage | I <sub>REF</sub>  | $V_{DD} = A_{VDD} = V_{AREF} = 5.5 \text{ V}$ $V_{SS} = A_{VSS} = 0.0 \text{ V}$ | -                      | 0.6      | 1.0               | mA   |
| Non linearity error                              |                   | V <sub>DD</sub> = A <sub>VDD</sub> = 5.0 V                                       | -                      | -        | ±2                |      |
| Zero point error                                 |                   | $V_{SS} = A_{VSS} = 0.0 \text{ V}$   | -                      | -        | ±2                | LSB  |
| Full scale error                                 |                   |  | -                      | -        | ±2                | LOD  |
| Total error                                      |                   | $V_{AREF} = 5.0 \text{ V}$   | -                      | -        | ±2                |      |

$$(V_{SS} = 0 \text{ V}, 2.7 \text{ V} \le V_{DD} < 4.5 \text{ V}, \text{Topr} = -40 \text{ to } 70^{\circ}\text{C})$$

| Parameter  | Symbol            | Condition  | Min                    | Тур.     | Max               | Unit |
|--|-------------------|--|------------------------|----------|-------------------|------|
| Analog reference voltage                         | $V_{AREF}$        |  | A <sub>VDD</sub> – 1.0 | -        | $A_{VDD}$         |      |
| Power supply voltage of analog control circuit   | A <sub>VDD</sub>  |  |                        | $V_{DD}$ |                   | V    |
| Analog reference voltage range (Note 4)          | $\Delta V_{AREF}$ |  | 2.5                    | -        | -                 | V    |
| Analog input voltage                             | V <sub>AIN</sub>  |  | V <sub>SS</sub>        | -        | V <sub>AREF</sub> |      |
| Power supply current of analog reference voltage | I <sub>REF</sub>  | $V_{DD} = A_{VDD} = V_{AREF} = 4.5V$<br>$V_{SS} = A_{VSS} = 0.0 V$ | -                      | 0.5      | 0.8               | mA   |
| Non linearity error                              |                   | $V_{DD} = A_{VDD} = 2.7 \text{ V}$                                 | _                      | -        | ±2                |      |
| Zero point error                                 |                   | $V_{SS} = 0.0 \text{ V}$   | -                      | -        | ±2                | LSB  |
| Full scale error                                 |                   |  | -                      | _        | ±2                | LOD  |
| Total error                                      |                   | $V_{AREF} = 2.7 \text{ V}$   | -                      | -        | ±2                |      |

- Note 1: The total error includes all errors except a quantization error, and is defined as a maximum deviation from the ideal conversion line.
- Note 2: Conversion time is different in recommended value by power supply voltage.

  About conversion time, please refer to "10-Bit AD Converter".
- Note 3: Please use input voltage to AIN input pin in limit of  $V_{AREF} V_{SS}$ . When voltage of range outside is input, conversion value becomes unsettled and gives affect to other channel conversion value.
- Note 4: Analog reference voltage range:  $\Delta V_{AREF} = V_{AREF} V_{SS}$
- Note 5: The  $A_{VDD}$  pin should be fixed on the  $V_{DD}$  level even though AD converter is not used.

AC Characteristics

(V  $_{SS} = 0$  V, V  $_{DD} = 4.5$  to 5.5 V, Topr = -40 to  $70^{\circ}C)$ 

| Parameter                    | Symbol | Condition                          | Min   | Тур.  | Max   | Unit |
|------------------------------|--------|------------------------------------|-------|-------|-------|------|
|                              |        | NORMAL1, 2 mode                    | 0.25  |       | 4     |      |
| Machine cycle time           | tov    | IDLE1, 2 mode                      | 0.25  | _     | 7     | μ\$  |
| Machine cycle time           | tcy    | SLOW1, 2 mode                      | 117.6 |       | 133.3 |      |
|                              |        | SLEEP1, 2 mode                     | 117.0 | _     | 133.3 |      |
| High level clock pulse width | twcH   | For external clock operation (XIN  |       | 31.25 |       | ns   |
| Low level clock pulse width  | twcL   | input), fc = 16 MHz                | _     | 31.23 | _     | 115  |
| High level clock pulse width | twcH   | For external clock operation (XTIN |       | 15.26 |       | 0    |
| Low level clock pulse width  | twcL   | input), fs = 32.768 kHz            | _     | 15.20 | _     | μS   |

$$(V_{SS} = 0 \text{ V}, V_{DD} = 2.7 \text{ to } 4.5 \text{ V}, \text{Topr} = -40 \text{ to } 70^{\circ}\text{C})$$

| Parameter                    | Symbol | Condition                          | Min   | Тур.  | Max   | Unit |
|------------------------------|--------|------------------------------------|-------|-------|-------|------|
|                              |        | NORMAL1, 2 mode                    | 0.5   |       | 133.3 |      |
| Machine avaletime            | 40.7   | IDLE1, 2 mode                      | 0.5   | _     |       | μ\$  |
| Machine cycle time           | tcy    | SLOW1, 2 mode                      | 117.6 |       |       |      |
|                              |        | SLEEP1, 2 mode                     | 117.0 | _     |       |      |
| High level clock pulse width | twcH   | For external clock operation (XIN  |       | 62.5  |       | ns   |
| Low level clock pulse width  | twcL   | input), fc = 8 MHz                 | _     | 02.5  | _     | 115  |
| High level clock pulse width | twcH   | For external clock operation (XTIN |       | 15.26 |       | 0    |
| Low level clock pulse width  | twcL   | input), fs = 32.768 kHz            | _     | 15.20 | _     | μS   |

Recommended Oscillating Conditions-1

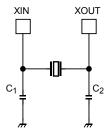
$$(V_{SS} = 0 \text{ V}, V_{DD} = 4.5 \text{ to } 5.5 \text{ V}, \text{Topr} = -40 \text{ to } 70^{\circ}\text{C})$$

| Parameter                     | Oscillator           | Oscillation             | Recommened Oscillator |                | Recommended Constant |                  |
|-------------------------------|----------------------|-------------------------|-----------------------|----------------|----------------------|------------------|
|                               |                      | Frequency               |                       |                | C <sub>1</sub>       | C <sub>2</sub>   |
| High-frequency<br>Oscillation | Ceramic<br>Resonator | 16 MHz                  | MURATA                | CSA16.00MXZ040 | 10 pF                | 10 pF            |
|                               |                      | 8 MHz                   | MURATA                | CSA8.00MTZ     | 30 pF                | 30 pF            |
|                               |                      |                         |                       | CST8.00MTW     | 30 pF (built-in)     | 30 pF (built-in) |
|                               |                      | 4.19 MHz                | MURATA                | CSA4.19MG      | 30 pF                | 30 pF            |
|                               |                      |                         |                       | CST4.19MGW     | 30 pF (built-in)     | 30 pF (built-in) |
| Low-frequency                 | Crystal Oscillator   | l Oscillator 32.768 kHz | SII                   | VT-200         | 6 pF                 | 6 pF             |
| Oscillation                   | Crystal Oscillator   |                         |                       |                |                      |                  |

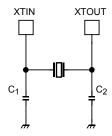
Recommended Oscillating Conditions-2

$$(V_{SS} = 0 \text{ V}, V_{DD} = 2.7 \text{ to } 5.5 \text{ V}, \text{Topr} = -40 \text{ to } 70^{\circ}\text{C})$$

| Doromotor                     | Oscillator           | Oscillation<br>Frequency | Recommened Oscillator |            | Recommended Constant |                  |
|-------------------------------|----------------------|--------------------------|-----------------------|------------|----------------------|------------------|
| Parameter                     |                      |                          |                       |            | C <sub>1</sub>       | C <sub>2</sub>   |
| High-frequency<br>Oscillation | Ceramic<br>Resonator | 8 MHz                    | MURATA                | CSA8.00MTZ | 30 pF                | 30 pF            |
|                               |                      |                          |                       | CST8.00MTW | 30 pF (built-in)     | 30 pF (built-in) |
|                               |                      | 4.19 MHz                 | MURATA                | CSA4.19MG  | 30 pF                | 30 pF            |
|                               |                      |                          |                       | CST4.19MGW | 30 pF (built-in)     | 30 pF (built-in) |



High-frequency oscillation



Low-frequency oscillation

- Note 1: When using the device (Oscillator) in places exposed to high electric fields such as cathoderay tubes, we recommend electrically shielding the package in order to maintain normal operating condition.
- Note 2: To ensure stable oscillation, the resonator position, load capacitance, etc. must be appropriate. Because there factors are greatly affected by board patterns, please be sure to evaluate operation on the board on which the device will actually be mounted.
- Note 3: The product numbers and specifications of the resonators by Murata Manufacturing Co., Ltd. are subject to change. For up-to-date information, please refer to the following URL: http://www.murata.co.jp/search/index.html